Preferred Device

Silicon Controlled RectifiersReverse Blocking Thyristors

Designed primarily for half-wave ac control applications, such as motor controls, heating controls, and power supplies; or wherever half-wave, silicon gate-controlled devices are needed.

Features

- Blocking Voltage to 800 Volts
- On-State Current Rating of 12 Amperes RMS at 80°C
- High Surge Current Capability 100 Amperes
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Minimum and Maximum Values of IGT, VGT and IH Specified for Ease of Design
- High Immunity to dv/dt 100 V/µsec Minimum at 125°C
- Pb-Free Packages are Available*

MAXIMUM RATINGS (T, I = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
$\begin{tabular}{lll} Peak Repetitive Off-State Voltage (Note 1) \\ (T_J = -40 to 125 ^{\circ}C, Sine Wave, \\ 50 to 60 Hz, Gate Open) & MCR12LD \\ & MCR12LM \\ & MCR12LN \\ \end{tabular}$	V _{DRM,} V _{RRM}	400 600 800	V
On-State RMS Current (180° Conduction Angles; T _C = 80°C)	I _{T(RMS)}	12	Α
Average On-State Current (180° Conduction Angles; T _C = 80°C)	I _{T(AV)}	7.6	Α
Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 125°C)	I _{TSM}	100	Α
Circuit Fusing Consideration (t = 8.3 ms)	l ² t	41	A ² sec
Forward Peak Gate Power (Pulse Width \leq 1.0 μ s, T _C = 80°C)	P _{GM}	5.0	W
Forward Average Gate Power (t = 8.3 ms, T _C = 80°C)	P _{G(AV)}	0.5	W
Forward Peak Gate Current (Pulse Width \leq 1.0 μ s, T _C = 80°C)	I _{GM}	2.0	Α
Operating Junction Temperature Range	TJ	-40 to 125	°C
Storage Temperature Range	T _{stg}	-40 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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SCRs 12 AMPERES RMS 400 thru 800 VOLTS





MARKING DIAGRAM



TO-220AB CASE 221A-09 STYLE 3

A = Assembly Location

′ = Year

WW = Work Week x = D, M, or N G = Pb-Free Package

AKA = Diode Polarity

PIN ASSIGNMENT				
1	Cathode			
2	Anode			
3	Gate			
4	Anode			

ORDERING INFORMATION

Device	Package	Shipping
MCR12LD	TO-220AB	50 Units / Rail
MCR12LDG	TO-220AB (Pb-Free)	50 Units / Rail
MCR12LM	TO-220AB	50 Units / Rail
MCR12LMG	TO-220AB (Pb-Free)	50 Units / Rail
MCR12LN	TO-220AB	50 Units / Rail
MCR12LNG	TO-220AB (Pb-Free)	50 Units / Rail

Preferred devices are recommended choices for future use and best overall value.

V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

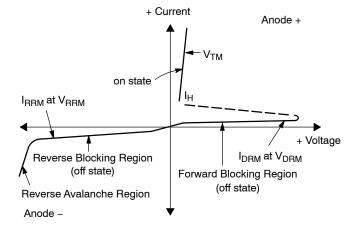
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	T_L	260	°C

ELECTRICAL CHARACTERISTICS (T _J = 25°C unless otherwise r	noted)					
Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Forward or Reverse Blocking Current (V _D = Rated V _{DRM} and V _{RRM} ; Gate Open)	$T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$	I _{DRM} , I _{RRM}	- -	_ _	0.01 2.0	mA
ON CHARACTERISTICS						
Peak Forward On-State Voltage (Note 2) (I _{TM} = 24 A)		V _{TM}	_	-	2.2	V
Gate Trigger Current (Continuous dc) $ (V_D = 12 \ V, \ R_L = 100 \ \Omega) $		I _{GT}	2.0	4.0	8.0	mA
Holding Current (V _D = 12 V, Gate Open, Initiating Current = 200 mA)		I _H	4.0	10	20	mA
Latch Current (V _D = 12 V, Ig = 20 mA)		ΙL	6.0	12	30	mA
Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, R_L = 100 \Omega)$		V _{GT}	0.5	0.65	0.8	V
DYNAMIC CHARACTERISTICS						
Critical Rate of Rise of Off–State Voltage (V _D = Rated V _{DRM} , Exponential Waveform, Gate Open, T _J = 125°C)	dv/dt	100	250	_	V/μs
Critical Rate of Rise of On–State Current IPK = 50 A; Pw = 40 μ sec; diG/dt = 1 A/ μ sec, Igt = 50 mA		di/dt	_	-	50	A/μs

^{2.} Indicates Pulse Test: Pulse Width ≤ 1.0 ms, Duty Cycle ≤ 2%.

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Off State Forward Voltage
I _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak On State Voltage
IH	Holding Current



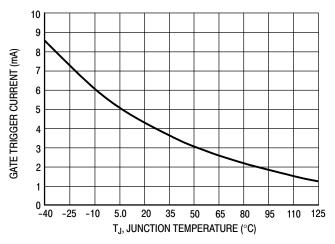
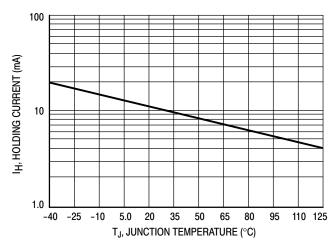


Figure 1. Typical Gate Trigger Current versus Junction Temperature

Figure 2. Typical Gate Trigger Voltage versus Junction Temperature





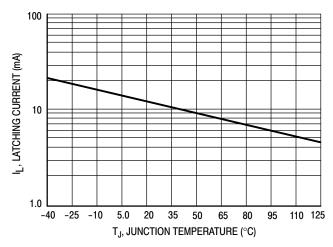


Figure 4. Typical Latching Current versus Junction Temperature

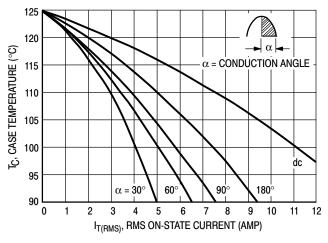


Figure 5. Typical RMS Current Derating

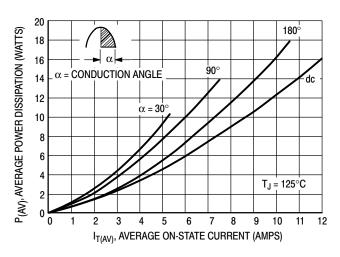


Figure 6. On-State Power Dissipation

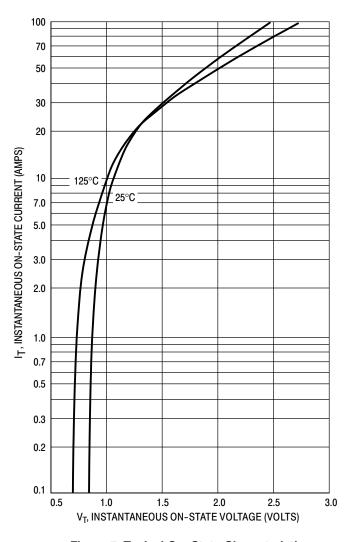


Figure 7. Typical On-State Characteristics

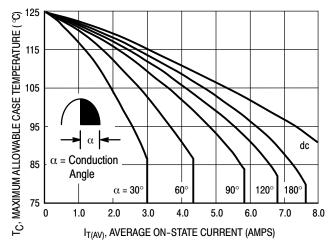
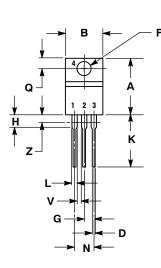
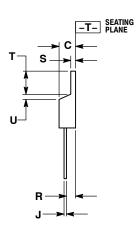


Figure 8. Average Current Derating

PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AF**





- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- CONTROLLING DIMENSION: INCH.
 DIMENSION Z DEFINES A ZONE WHERE ALL
 BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLE 3:

PIN 1. CATHODE

- 2. ANODE GATE
- 3.
- ANODE

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